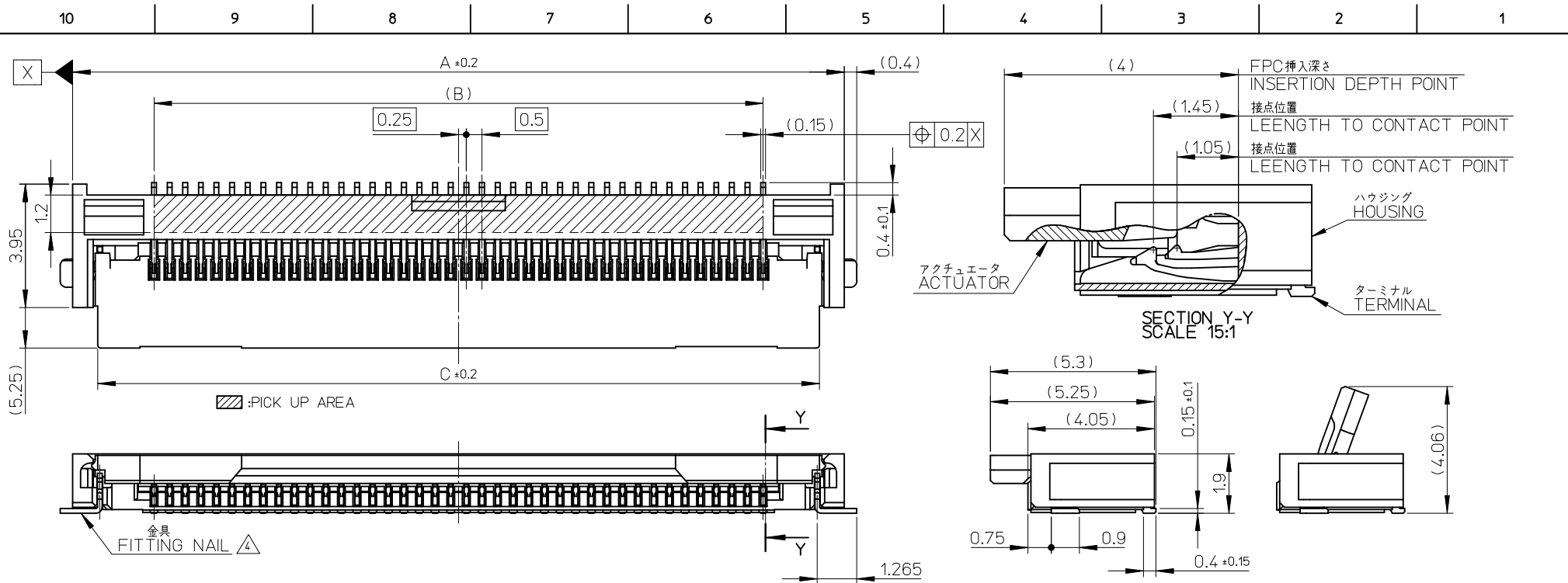




注記 NOTES

1. 使用材料 MATERIAL
ハウジング : 液晶ポリマー ガラス充填, UL94V-0(ベージュ)
HOUSING LIQUID CRYSTAL POLYMER
GLASS FILLED,UL94V-0(BEIGE)
アクチュエータ : ポリアミド ガラス充填, UL94V-0(黒)
ACTUATOR POLYAMIDE GLASS FILLED, UL94V-0(BLACK)
ターミナル : リン青銅(t=0.15)
TERMINAL PHOSPHOR BRONZE
金具 : リン青銅(t=0.15)
FITTING NAIL PHOSPHOR BRONZE

2. めっき仕様 PLATING
ターミナル TERMINAL
コンタクト部: 部分金めっき (0.05 μm以上)
テール部: 部分金めっき
下地: ニッケルめっき (1.0 μm以上)

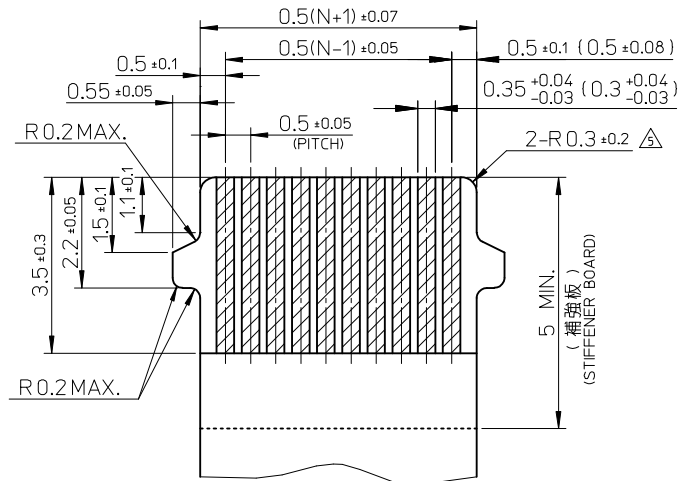
CONTACT AREA : SEPARATED GOLD PLATING
(0.05 MICROMETER MIN.)
SOLDER TAIL AREA : SEPARATED GOLD PLATING
UNDERPLATE : NICKEL OVERALL
(1.0 MICROMETER MIN.)

金具 FITTING NAIL
銅めっき (1.0 μm以上)
下地: ニッケルめっき (1.0 μm以上)
TIN PLATING (1.0 MICROMETER MIN.)
UNDER PLATING : NICKEL PLATING
(1.0 MICROMETER MIN.)

3. エンボスター プラグ包時は、アクチュエータが閉じた状態とする。
IN THE PACKAGE, ACTUATOR OF
PART SHOULD BE CLOSED.

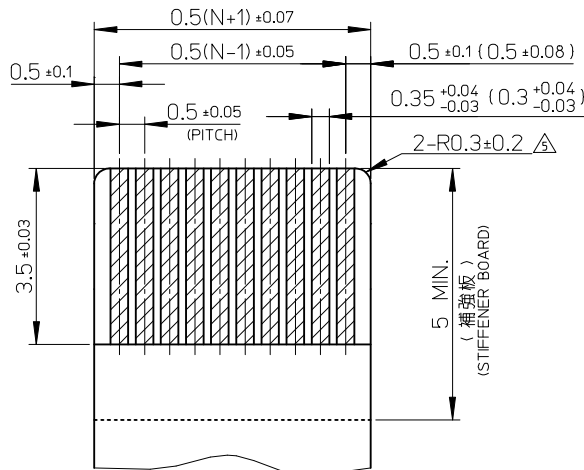
- △ バターン剥離止め用金具
FITTING NAIL FOR PREVENTION OF
PEELING OF P.C.B. PATTERN.
△ R0.3は、FPC 導体部にかからないこと。
R0.3 MUST NOT BE OVERLAPPED
TO PATTERN OF FPC.
6. N: 極数 N: CIRCUIT.
7. ELV及びRoHS適合品
ELV AND RoHS COMPLIANT
8. テールと金具を併せた平坦度は0.1mm以下とする。
TAILS AND NAILS COPLANALITY
TO BE 0.1mm MAX.

REVISED EC NO: J2017-0308 DRWN: JASANUMA 2016/12/06 CHKD: YKOBAYASHI 02/2016/12/06 APPR: TKUSUHARA 01 2016/12/07	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)			DIMENSION STYLE MM ONLY		SCALE 8:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION
		0.25 UNDER		± 0.03	DRAWN BY	DATE	TITLE 0.5 FPC CONN ZIF E/O 2 CONTACTS TYPE HSG ASSY (H=1.9) molex		
		0.25 OVER 0.5 UNDER		± 0.05	JASANUMA	2014/02/25			
		0.5 OVER 1.0 UNDER		± 0.1	CHECKED BY	DATE			
		1.0 OVER 10 UNDER		± 0.2	KTAKAHASHI	2014/07/28			
		10 OVER 30 UNDER		± 0.25	APPROVED BY	DATE			
		30 OVER		± 0.3	YNOGAWA	2014/11/10	DOCUMENT NO. SD-505110-001	SHEET NO. 1 OF 3	
		ANGULAR ±1 °			MATERIAL NO.				
					SEE SHEET 3				
J	REV	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			



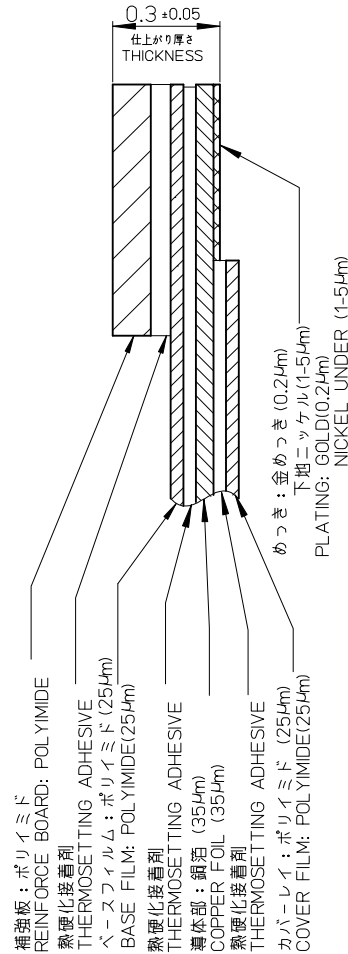
適合FPC/FFC推奨寸法
APPLICABLE FPC/FFC
RECOMMENDED DIMENSION

(): FFCに適用
(): APPLY TO FFC



耳無し適合FPC/FFC推奨寸法
APPLICABLE NON-TAB FPC/FFC
RECOMMENDED DIMENSION

(): FFCに適用
(): APPLY TO FFC



FPC構成推奨仕様
STRUCTURE OF FPC

FPC/FFCについて ABOUT FPC/FFC

打ち抜き方向は導体側から補強板側を推奨します。
導体部については軟箔銅35 μ mまたは50 μ mを推奨します。
FFCに規定された定格温度がFFC単体前提である場合が御座います。
コネクタと組み合わせての実使用に置いて、接着層が劣化するなどの信頼性を満足できないケースを回避するため、
実機での評価/確認をお願い致します。
RECOMMENDED PUNCHING DIRECTION: FROM CONDUCTOR SIDE TO STIFFENER SIDE
RECOMMENDED CONDUCTOR SPEC: SOFT COPPER FOIL
RECOMMENDED CONDUCTOR THICKNESS: 35 MICROMETER OR 50 MICROMETER
NOTE: WHEN ACTUALLY USING IT WITH CONNECTOR, PLEASE DO THE EVALUATION AND THE
CONFIRMATION WITH AN ACTUAL EQUIPMENT TO EVADE THE CASE WHERE RELIABILITY
CANNOT BE FILLED (THE ADHESIVE LINE OF FFC IS DETERIORATED ETC.)

FPCについて ABOUT FPC

補強フィルム材質はポリイミドを推奨します。ベースフィルムは25 μ mを推奨します。
接着剤は熱硬化接着剤を推奨します。
尚、接着剤の接点部への付着は導通不良の原因になりますので、染み出しが無い様お願い致します。
RECOMMENDED MATERIAL/THICKNESS.
RECOMMENDED STIFFENER MATERIAL: POLYIMIDE
RECOMMENDED BASE FILM THICKNESS: 25 MICROMETER
RECOMMENDED ADHESIVE: THERMOSETTING ADHESIVE
NOTE: PLEASE PUT APPROPRIATE AMOUNT OF ADHESIVE ON ADHEREND BECAUSE THERE IS A
POSSIBILITY THAT THE EXTRA ADHESIVE CAUSES THE DEFECT IN ELECTRICAL CONTINUITY.
THERE IS A POSSIBILITY THAT THE PRESCRIPT TEMPERATURE OF FFC IS SET TO SINGLE IT.

補強板: ポリイミド
REINFORCE BOARD: POLYIMIDE
熱硬化接着剤
THERMOSETTING ADHESIVE
ベースフィルム: ポリイミド (25 μ m)
BASE FILM: POLYIMIDE (25 μ m)
熱硬化接着剤
THERMOSETTING ADHESIVE
導体部: 銅箔 (35 μ m)
COPPER FOIL (35 μ m)
熱硬化接着剤
THERMOSETTING ADHESIVE
カバーレイ: ポリイミド (25 μ m)
COVER FILM: POLYIMIDE (25 μ m)

FPC構成推奨仕様
STRUCTURE OF FPC

SEE SHEET 1 EC NO: J2017-0308 DRAWN: JASUNUMA 2016/12/06 CHKD: YKOBAYASHI 10/2016/12/06 APPR: KUSUJHARA01 2016/12/07	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 10:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		0.25 UNDER		± 0.03	DRAWN BY	DATE	TITLE 0.5 FPC CONN ZIF E/O 2 CONTACTS TYPE HSG ASSY (H=1.9)			
		0.25 OVER 0.5 UNDER		± 0.05	JASUNUMA	2014/02/25				
		0.5 OVER 1.0 UNDER		± 0.1	CHECKED BY	DATE	molex			
		1.0 OVER 10 UNDER		± 0.2	KTAKAHASHI	2014/07/28				
		10 OVER 30 UNDER		± 0.25	APPROVED BY	DATE	SD-505110-001			
		30 OVER		± 0.3	YNOGAWA	2014/11/10				
		ANGULAR ±1 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
			SEE SHEET 3				2 OF 3			
	REV	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

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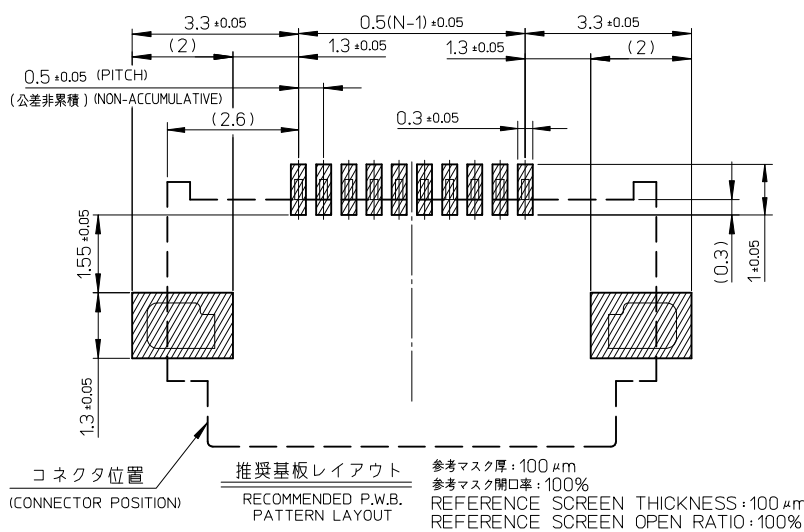
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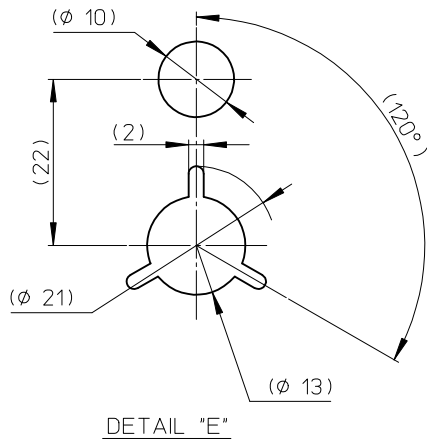
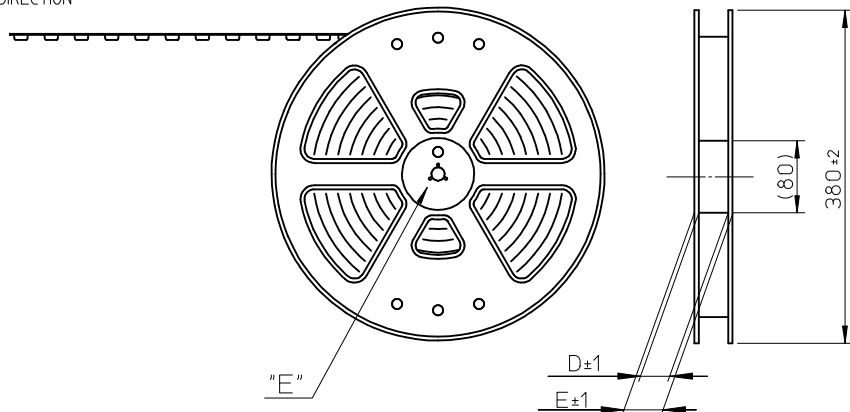
43.1	39.5	44.7	505110-8091	80
38.1	34.5	39.7	505110-7091	70
37.1	33.5	38.7	505110-6891	68
35.1	31.5	36.7	505110-6491	64
33.1	29.5	34.7	505110-6091	60
28.1	24.5	29.7	505110-5091	50
25.6	22.0	27.2	505110-4591	45
23.1	19.5	24.7	505110-4091	40
20.6	17	22.2	505110-3591	35
18.1	14.5	19.7	505110-3091	30
17.1	13.5	18.7	505110-2891	28
16.1	12.5	17.7	505110-2691	26
15.1	11.5	16.7	505110-2491	24
14.1	10.5	15.7	505110-2291	22
13.1	9.5	14.7	505110-2091	20

CONNECTOR SERIES NO. 505110-**11

SEE SHEET 1 EC NO.: J2017-0308 DRWN: JASUNUMA 2016/12/06 CHKD: YKOBAYASHI 2016/12/06 APPR: TKUSUHARA01 2016/12/07	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)			DIMENSION STYLE MM ONLY		SCALE 5:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION				
		0.25 UNDER ± 0.03			DRAWN BY	DATE	TITLE 0.5 FPC CONN ZIF E/O 2 CONTACTS TYPE HSG ASSY (H=1.9) molex						
		0.25 OVER 0.5 UNDER ± 0.05			JASUNUMA	2014/02/25							
		0.5 OVER 1.0 UNDER ± 0.1			CHECKED BY	DATE							
		1.0 OVER 10 UNDER ± 0.2			KTAKAHASHI	2014/07/28							
		10 OVER 30 UNDER ± 0.25			APPROVED BY	DATE							
		30 OVER ± 0.3			YNOGAWA	2014/11/10							
		ANGULAR ±1 °			MATERIAL NO.					DOCUMENT NO.		SHEET NO.	
					SEE CHART					SD-505110-001		3 OF 3	
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							
	REV												

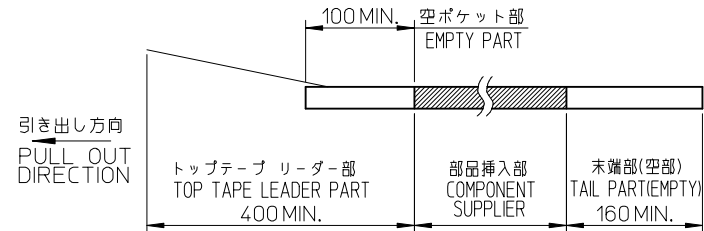
引き出し方向

PULL OUT
DIRECTION



NOTES

1. 梱包数量 : 3000個/リール
NUMBER OF CONNECTORS : 3000PIECES/REEL
2. リードテープ長さ
LEAD TAPE LENGTH



3. カバーテープの剥離強度については、IEC60286-3に準拠
COVER TAPE PEEL FORCE IS DEFINED BY IEC 60286-3.
4. 製品詳細寸法については図面 SD-505110-001を参照下さい。
FOR DIMENSIONS OF PRODUCT, REFER TO SD-505110-001.
5. 材料 MATERIAL
キャリアテープ : ポリスチレン
CARRIER TAPE : POLYSTYRENE
トップテープ : ポリエチレンテレフタレート, ポリエチレン
TOP TAPE : POLYETHYLENE TEREPHTHALATE , POLYETHYLENE
リール : ポリスチレン<リサイクル材を含む>
REEL : POLYSTYRENE<RECYCLE MATERIAL CONTAINED>
6. ELV及びRoHS適合品 ELV AND RoHS COMPLIANT

REVISED EC NO.: J2015-1582 DRWN:KONDO CHKD:KTAKAHASHI APPR:KMORI KAWA	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)			DIMENSION STYLE MM ONLY		SCALE 1:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION			
		0.25	UNDER	UNDER	± 0.03	DRAWN BY	DATE	TITLE 0.5 FPC CONN ZIF E/O 2 CONTACTS TYPE EMBSTP PACKAGE (H=1.9)				
		0.25	OVER	0.5	UNDER	± 0.05	JASANUMA					2014/02/25
		0.5	OVER	1.0	UNDER	± 0.1	CHECKED BY	DATE	DOCUMENT NO. SD-505110-002			
		1.0	OVER	10	UNDER	± 0.2	KTAKAHASHI	2014/07/30				
		10	OVER	30	UNDER	± 0.25	APPROVED BY	DATE	SHEET NO. 1 OF 2			
		30	OVER		± 0.3	YNOGAWA	2014/11/10					
		ANGULAR ±1 °				MATERIAL NO.		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				SIZE A3						

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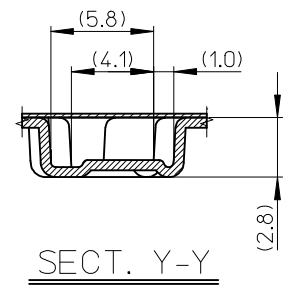
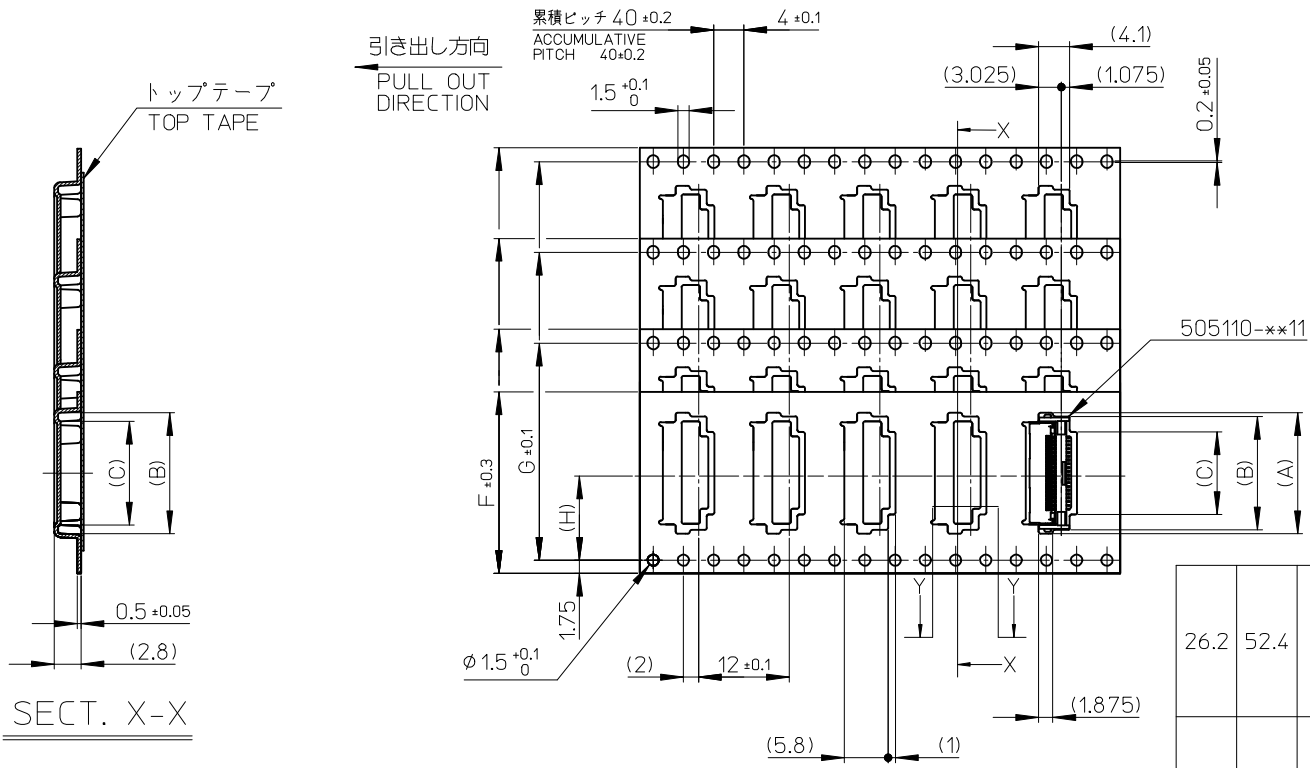
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26.2	52.4	56	61.4	57.4	40.9	44.9	46	505110-8091	80
					35.9	39.9	41	505110-7091	70
					34.9	38.9	40	505110-6891	68
					32.9	36.9	38	505110-6491	64
					30.9	34.9	36	505110-6091	60
20.2	40.4	44	49.4	45.4	25.9	29.9	31	505110-5091	50
					23.4	27.4	28.5	505110-4591	45
					20.9	24.9	26	505110-4091	40
					18.4	22.4	23.5	505110-3591	35
14.2	28.4	32	37.4	33.4	15.9	19.9	21	505110-3091	30
					14.9	18.9	20	505110-2891	28
					13.9	17.9	19	505110-2691	26
					12.9	16.9	18	505110-2491	24
					11.9	15.9	17	505110-2291	22
11.5	---	24	29.4	25.4	10.9	14.9	16	505110-2091	20
H	G	F	E	D	C	B	A	EMBOSSED PACKAGE オーダー番号 ORDER NO.	Ckt

SEE SHEET 1

EC NO.: J2015-1582

DRWN: KONDO 2015/05/28

CHKD: TAKAHASHI 2015/05/29

APPR: KIMORI KAWA 2015/06/26

DESCRIPTION

0.25	UNDER	UNDER	± 0.03	
0.25	OVER	0.5	UNDER	± 0.05
0.5	OVER	1.0	UNDER	± 0.1
1.0	OVER	10	UNDER	± 0.2
10	OVER	30	UNDER	± 0.25
30	OVER			± 0.3
ANGULAR	± 1	°		

DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

DIMENSION STYLE

MM ONLY

DRAWN BY

JASANUMA

DATE

2014/02/25

CHECKED BY

KTAKAHASHI

DATE

2014/07/30

APPROVED BY

YNOGAWA

DATE

2014/11/10

MATERIAL NO.

SEE CHART

SIZE

A3

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INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

SCALE

DESIGN UNITS

METRIC

THIRD ANGLE
PROJECTION

0.5 FPC CONN ZIF E/O
2 CONTACTS TYPE
EMBSTP PACKAGE (H=1.9)

molex

SD-505110-002

DOCUMENT NO.

SD-505110-002

SHEET NO.

2 OF 2